



## COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

## **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
Q2	$22  30V  20m\Omega @ V_{GS} = 10V$		9.1A
QZ	300	32mΩ @ V <sub>GS</sub> = 4.5V	7.2A
Q1	-30V	45mΩ @ V <sub>GS</sub> = -10V	-6A
		65mΩ @ V <sub>GS</sub> = -4.5V	-5A

### Description

This new generation MOSFET has been designed to minimize the onstate resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- **Power Management Functions**
- Analog Switch
- Load Switch

Notes:

#### Features

- Complementary Pair MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## Mechanical Data

- Case:
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072g (approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMC3018LSD-13	SO-8	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and 3 <1000ppm antimony compounds. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# Marking Information



⊃¦¦ = Manufacturer's Marking C3018LD = Product Type Marking Code YYWW = Date Code Marking YY or  $\overline{YY}$  = Year (ex: 14 = 2014) WW = Week (01 - 53) YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



# Maximum Ratings N-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain Source Voltage		V <sub>DSS</sub>	30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Drain Current (Note 5) $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		ID	9.1 7.7	А
Pulsed Drain Current (Note 6)		I <sub>DM</sub>	32	А

# Maximum Ratings P-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain Source Voltage		V <sub>DSS</sub>	-30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Drain Current (Note 5)	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-6 -5	A
Pulsed Drain Current (Note 6)		I <sub>DM</sub>	-21	A

#### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

		Unit
PD	2.5	W
R <sub>0JA</sub>	50	°C/W
TJ, TSTG	-55 to +150	°C
	<b>T T</b>	

# Electrical Characteristics N-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			-				
Drain-Source Breakdown Voltage	BVDSS	30	_		V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current	IDSS	<u> </u>	_	1	μA	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	± 100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						-	
Gate Threshold Voltage	V <sub>GS(th)</sub>	1	1.9	2.1	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	18 29	20 32	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 6.9A V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5.0A	
Forward Transfer Admittance	Y <sub>fs</sub>	_	10	_	S	V <sub>DS</sub> = 5V, I <sub>D</sub> = 6.9A	
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	0.5	_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS							
Input Capacitance	C <sub>iss</sub>	_	631		pF		
Output Capacitance	C <sub>oss</sub>	_	147		pF		
Reverse Transfer Capacitance	C <sub>rss</sub>		99		pF		
Gate Resistance	R <sub>G</sub>	_	0.9	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz	
SWITCHING CHARACTERISTICS							
Total Gate Charge	Qg		5.9 12.4			$V_{DS}$ = 15V, $V_{GS}$ = 4.5V, $I_D$ = 7A $V_{DS}$ = 15V, $V_{GS}$ = 10V, $I_D$ = 9A	
Gate-Source Charge	Q <sub>gs</sub>	—	1.8		nC	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 9A	
Gate-Drain Charge	Q <sub>gd</sub>		3.4			V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 9A	

Notes: 5. Device mounted on FR-4 PCB, on 2oz. Copper pads with  $R_{OJA} = 50^{\circ}$ C/W 6. Repetitive rating, pulse width limited by junction temperature.

7. Short duration pulse test used to minimize self-heating effect.



## Electrical Characteristics P-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	· · ·					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30		_	V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_		-1.0	μA	V <sub>DS</sub> = -24V, V <sub>GS</sub> = 0V
Gate-Source Leakage	IGSS	_	_	± 100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)				_		
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1	-1.7	-2.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	D		35	45		V <sub>GS</sub> = -10V, I <sub>D</sub> = -6A
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	_	56	65	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5.0A
Forward Transfer Admittance	Y <sub>fs</sub>	_	8.2	_	S	$V_{DS} = -5V, I_D = -6A$
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	-0.5	_	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>iss</sub>	_	722	_	pF	
Output Capacitance	C <sub>oss</sub>	_	114	1	pF	$V_{DS} = -15V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	Crss	_	92		pF	
Gate Resistance	R <sub>G</sub>	_	1.9		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
SWITCHING CHARACTERISTICS						
Total Gate Charge	Qg		7.0			$V_{DS}$ = -15V, $V_{GS}$ = -4.5V, $I_D$ = -6A
	Чg		13.7		nC	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -6A
Gate-Source Charge	Q <sub>gs</sub>	-	1.7			$V_{DS}$ = -15V, $V_{GS}$ = -4.5V, $I_D$ = -6A
Gate-Drain Charge	Q <sub>gd</sub>		4.1			V <sub>DS</sub> = -15V, V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -6A



















## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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